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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	8052
Core Size	8-Bit
Speed	12.58MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	POR, PSM, PWM, Temp Sensor, WDT
Number of I/O	34
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 10x24b; D/A 1x12b, 2x16b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	52-QFP
Supplier Device Package	52-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/aduc845bsz8-3

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Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
AUXILIARY ADC ANALOG INPUTS (ADuC845 ONLY)					
Differential Input Voltage Ranges[5,6]					
Bipolar Mode (ADC1CON.5 = 0)		$\pm V_{REF}$		V	REFIN = REFIN(+) − REFIN(−) (or Int 1.25 V_{REF})
Unipolar Mode (ADC1CON.5 = 1)		0 − V_{REF}		V	REFIN = REFIN(+) − REFIN(−) (or Int 1.25 V_{REF})
Average Analog Input Current		125		nA/V	
Analog Input Current Drift		±2		pA/V/°C	
Absolute AIN/AINCOM Voltage Limits[2,7]	A_{GND} − 0.03		AV_{DD} + 0.03	V	
Normal Mode Rejection 50 Hz/60 Hz[2]					
On AIN and REFIN	75			dB	50 Hz/60 Hz ± 1 Hz, 16.6 Hz Fadc, SF = 52H, chop on, REJ60 on
	100			dB	50 Hz ± 1 Hz, 16.6 Hz Fadc, SF = 52H, chop on
	67			dB	50 Hz/60 Hz ± 1 Hz, 50 Hz Fadc, SF = 52H, chop off, REJ60 on
	100			dB	50 Hz ± 1 Hz, 50 Hz Fadc, SF = 52H, chop off
ADC SYSTEM CALIBRATION					
Full-Scale Calibration Limit			+1.05 × FS	V	
Zero-Scale Calibration Limit	−1.05 × FS			V	
Input Span	0.8 × FS		2.1 × FS	V	
DAC					
Voltage Range		0 − V_{REF}		V	DACCON.2 = 0
		0 − AV_{DD}		V	DACCON.2 = 1
Resistive Load		10		kΩ	From DAC output to AGND
Capactive Load		100		pF	From DAC output to AGND
Output Impedance		0.5		Ω	
I_{SINK}		50		µA	
DC Specifications[8]					
Resolution	12			Bits	
Relative Accuracy		±3		LSB	
Differential Nonlinearity			−1	LSB	Guaranteed 12-bit monotonic
Offset Error			±50	mV	
Gain Error			±1	%	AV_{DD} range
		±1		%	V_{REF} range
AC Specifications[2,8]					
Voltage Output Settling Time		15		µs	Settling time to 1 LSB of final value
Digital-to-Analog Glitch Energy		10		nVs	1 LSB change at major carry
INTERNAL REFERENCE					
ADC Reference					Chop enabled
Reference Voltage	1.25 − 1%	1.25	1.25 + 1%	V	Initial tolerance @ 25°C, V_{DD} = 5 V
Power Supply Rejection		45		dB	
Reference Tempco		100		ppm/°C	
DAC Reference					
Reference Voltage	2.5 − 1%	2.5	2.5 + 1%	±1% V	Initial tolerance @ 25°C, V_{DD} = 5 V
Power Supply Rejection		50		dB	
Reference Tempco		±100		ppm/°C	
TEMPERATURE SENSOR (ADuC845 ONLY)					
Accuracy		±2		°C	
Thermal Impedance		90		°C/W	MQFP
		52		°C/W	LFCSP

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
TRANSDUCER BURNOUT CURRENT SOURCES					
AIN+ Current		−100		nA	AIN+ is the selected positive input (AIN4 or AIN6 only) to the primary ADC
AIN− Current		100		nA	AIN− is the selected negative input (AIN5 or AIN7 only) to the primary ADC
Initial Tolerance at 25°C		±10		%	
Drift		0.03		%/°C	
EXCITATION CURRENT SOURCES					
Output Current		200		µA	Available from each current source
Initial Tolerance at 25°C		±10		%	
Drift		200		ppm/°C	
Initial Current Matching at 25°C		±1		%	Matching between both current sources
Drift Matching		20		ppm/°C	
Line Regulation (AV_{DD})		1		µA/V	AV_{DD} = 5 V ± 5%
Load Regulation		0.1		µA/V	
Output Compliance[2]	AGND		AV_{DD} − 0.6	V	
POWER SUPPLY MONITOR (PSM)					
AV_{DD} Trip Point Selection Range	2.63		4.63	V	Four trip points selectable in this range
AV_{DD} Trip Point Accuracy			±3.0	%	T_{MAX} = 85°C
			±4.0	%	T_{MAX} = 125°C
DV_{DD} Trip Point Selection Range	2.63		4.63	V	Four trip points selectable in this range
DV_{DD} Trip Point Accuracy			±3.0	%	T_{MAX} = 85°C
			±4.0	%	T_{MAX} = 125°C
CRYSTAL OSCILLATOR (XTAL1 AND XTAL2)					
Logic Inputs, XTAL1 Only[2]					
V_{INL}, Input Low Voltage			0.8	V	DV_{DD} = 5 V
			0.4	V	DV_{DD} = 3 V
V_{INH}, Input Low Voltage	3.5			V	DV_{DD} = 5 V
	2.5			V	DV_{DD} = 3 V
XTAL1 Input Capacitance		18		pF	
XTAL2 Output Capacitance		18		pF	
LOGIC INPUTS					
All Inputs Except SCLOCK, RESET, and XTAL1[2]					
V_{INL}, Input Low Voltage			0.8	V	DV_{DD} = 5 V
			0.4	V	DV_{DD} = 3 V
V_{INH}, Input Low Voltage	2.0			V	
SCLOCK and RESET Only (Schmidt Triggered Inputs)[2]					
V_{T+}	1.3		3.0	V	DV_{DD} = 5 V
	0.95		2.5	V	DV_{DD} = 3 V
V_{T-}	0.8		1.4	V	DV_{DD} = 5 V
	0.4		1.1	V	DV_{DD} = 3 V
$V_{T+} - V_{T-}$	0.3		0.85	V	DV_{DD} = 5 V or 3 V
Input Currents					
Port 0, P1.0 to P1.7, $\overline{EA}$			±10	µA	V_{IN} = 0 V or V_{DD}
RESET			±10	µA	V_{IN} = 0 V, DV_{DD} = 5 V
	35		105	µA	V_{IN} = DV_{DD}, DV_{DD} = 5 V, internal pull-down
Port 2, Port 3			±10	µA	V_{IN} = DV_{DD}, DV_{DD} = 5 V
	−180		−660	µA	V_{IN} = 2 V, DV_{DD} = 5 V
	−20		−75	µA	V_{IN} = 0.45 V, DV_{DD} = 5 V
Input Capacitance		10		pF	All digital inputs

ADC CIRCUIT INFORMATION

The ADuC845 incorporates two 10-channel (8-channel on the MQFP package) 24-bit Σ-Δ ADCs, while the ADuC847 and ADuC848 each incorporate a single 10-channel (8-channel on the MQFP package) 24-bit and 16-bit Σ-Δ ADC.

Each device also includes an on-chip programmable gain amplifier and configurable buffering (neither is available on the auxiliary ADC on the ADuC845). The devices also incorporate digital filtering intended for measuring wide dynamic range and low frequency signals such as those in weigh-scale, strain-gage, pressure transducer, or temperature measurement applications.

The ADuC845/ADuC847/ADuC848 can be configured as four or five (MQFP/LFCSP package) fully-differential input channels or as eight or ten (MQFP/LFCSP package) pseudo differential input channels referenced to AINCOM. The ADC on each device (primary only on the ADuC845) can be fully buffered internally, and can be programmed for one of eight input ranges from ±20 mV to ±2.56 V (V_{REF} × 1.024). Buffering the input channel means that the device can handle significant source impedances on the selected analog input and that RC filtering (for noise rejection or RFI reduction) can be placed on the analog inputs. If the ADC is used with internal buffering disabled (ADC0CON1.7 = 1, ADC0CON1.6 = 0), these unbuffered inputs provide a dynamic load to the driving source. Therefore, resistor/capacitor combinations on the inputs can cause dc gain errors, depending on the output impedance of the source that is driving the ADC inputs.

Table 8 and Table 9 show the allowable external resistance/capacitance values for unbuffered mode such that no gain error at the 16-bit and 20-bit levels, respectively, is introduced. When used with internal buffering enabled, it is recommended that a capacitor (10 nF to 100 nF) be placed on the input to the ADC (usually as part of an antialiasing filter) to aid in noise performance.

The input channels are intended to convert signals directly from sensors without the need for external signal conditioning. With internal buffering disabled (relevant bits set/cleared in ADC0CON1), external buffering might be required.

When the internal buffer is enabled, it might be necessary to offset the negative input channel by +100 mV and to offset the positive channel by −100 mV if the reference range is AV_{DD}. This accounts for the restricted common-mode input range in the buffer. Some circuits, for example, bridge circuits, are inherently suitable to use without having to offset where the output voltage is balanced around $V_{REF}/2$ and is not sufficiently large to encroach on the supply rails. Internal buffering is not available on the auxiliary ADC (ADuC845 only). The auxiliary ADC (ADuC845 only) is fixed at a gain range of ±2.50 V.

The ADCs use a Σ-Δ conversion technique to realize up to 24 bits on the ADuC845 and the ADuC847, and up to 16 bits on the ADuC848 of no missing codes performance (20 Hz update rate, chop enabled). The Σ-Δ modulator converts the sampled input signal into a digital pulse train whose duty cycle contains the digital information. A $sinc^3$ programmable low-pass filter (see Table 28) is then used to decimate the modulator output data stream to give a valid data conversion result at programmable output rates. The signal chain has two modes of operation, chop enabled and chop disabled. The $\overline{CHOP}$ bit in the ADCMODE register enables or disables the chopping scheme.

Table 8. Maximum Resistance for No 16-Bit Gain Error (Unbuffered Mode)

	External Capacitance					
Gain	**0 pF**	**50 pF**	**100 pF**	**500 pF**	**1000 pF**	**5000 pF**
1	111.3 kΩ	27.8 kΩ	16.7 kΩ	4.5 kΩ	2.58 kΩ	700 Ω
2	53.7 kΩ	13.5 kΩ	8.1 kΩ	2.2 kΩ	1.26 kΩ	360 Ω
4	25.4 kΩ	6.4 kΩ	3.9 kΩ	1.0 kΩ	600 Ω	170 Ω
8–128	10.7 kΩ	2.9 kΩ	1.7 kΩ	480 Ω	270 Ω	75 Ω

Table 9. Maximum Resistance for No 20-Bit Gain Error (Unbuffered Mode)

	External Capacitance					
Gain	**0 pF**	**50 pF**	**100 pF**	**500 pF**	**1000 pF**	**5000 pF**
1	84.9 kΩ	21.1 kΩ	12.5 kΩ	3.2 kΩ	1.77 kΩ	440 Ω
2	42.0 kΩ	10.4 kΩ	6.1 kΩ	1.6 kΩ	880 Ω	220 Ω
4	20.5 kΩ	5.0 kΩ	2.9 kΩ	790 Ω	430 Ω	110 Ω
8–128	8.8 kΩ	2.3 k Ω	1.3 k Ω	370 Ω	195 Ω	50 Ω

ADC Noise Performance with Chop Disabled ($\overline{CHOP}$ = 1)

Table 14 through Table 17 show the output rms noise and output peak-to-peak resolution in bits (rounded to the nearest 0.5 LSB) for some typical output update rates. The numbers are typical and are generated at a differential input voltage of 0 V and a common-mode voltage of 2.5 V. The output update rate is selected via the SF7 to SF0 bits in the SF filter register. Note that the peak-to-peak resolution figures represent the resolution for which there is no code flicker within a 6-sigma limit.

The output noise comes from two sources. The first source is the electrical noise in the semiconductor devices (device noise) used in the implementation of the modulator. The second source is quantization noise, which is added when the analog input is converted to the digital domain. The device noise is at a low level and is independent of frequency. The quantization noise starts at an even lower level but rises rapidly with increasing frequency to become the dominant noise source.

The numbers in the tables are given for the bipolar input ranges. For the unipolar ranges, the rms noise numbers are the same as the bipolar range, but the peak-to-peak resolution is based on half the signal range, which effectively means losing 1 bit of resolution. Typically, the performance of the ADC with chop disabled shows a 0.5 LSB degradation over the performance with chop enabled.

Table 14. ADuC845 and ADuC847 Typical Output RMS Noise (μV) vs. Input Range and Update Rate with Chop Disabled

SF Word	Data Update Rate (Hz)	Input Range							
		±20 mV	±40 mV	±80 mV	±160 mV	±320 mV	±640 mV	±1.28 V	±2.56 V
3	1365.33	30.64	24.5	56.18	100.47	248.39	468.65	774.36	1739.5
13	315.08	2.07	1.95	2.28	3.24	8.22	13.9	20.98	49.26
68	59.36	0.85	0.79	1.01	0.99	0.79	1.29	2.3	3.7
82	49.95	0.83	0.77	0.85	0.77	0.91	1.12	1.59	3.2
255	16.06	0.52	0.58	0.59	0.48	0.52	0.57	1.16	1.68

Table 15. ADuC845 and ADuC847 Typical Peak-to-Peak Resolution (Bits) vs. Input Range and Update Rate with Chop Disabled

SF Word	Data Update Rate (Hz)	Input Range							
		±20 mV	±40 mV	±80 mV	±160 mV	±320 mV	±640 mV	±1.28 V	±2.56 V
3	1365.33	7.5	9	9	9	9	9	9	9
13	315.08	11.5	12.5	13.5	14	13.5	14	14	14
68	59.36	13	14	14.5	15.5	17	17	17.5	18
82	49.95	13	14	15	16	16.5	17.5	18	18
255	16.06	13.5	14.5	15.5	16.5	17.5	18.5	18.5	19

Table 16. ADuC848 Typical Output RMS Noise (μV) vs. Input Range and Update Rate with Chop Disabled

SF Word	Data Update Rate (Hz)	Input Range							
		±20 mV	±40 mV	±80 mV	±160 mV	±320 mV	±640 mV	±1.28 V	±2.56 V
3	1365.33	30.64	24.5	56.18	100.47	248.39	468.65	774.36	1739.5
13	315.08	2.07	1.95	2.28	3.24	8.22	13.9	20.98	49.26
69	59.36	0.85	0.79	1.01	0.99	0.79	1.29	2.3	3.7
82	49.95	0.83	0.77	0.85	0.77	0.91	1.12	1.59	3.2
255	16.06	0.52	0.58	0.59	0.48	0.52	0.57	1.16	1.68

Table 17. ADuC848 Typical Peak-to-Peak Resolution (Bits) vs. Input Range and Update Rate with Chop Disabled

SF Word	Data Update Rate (Hz)	Input Range							
		±20 mV	±40 mV	±80 mV	±160 mV	±320mV	±640mV	±1.28 V	±2.56 V
3	1365.33	7.5	9	9	9	9	9	9	9
13	315.08	11.5	12.5	13.5	14	13.5	14	14	14
68	59.36	13	14	14.5	15.5	16	16	16	16
82	49.95	13	14	15	16	16	16	16	16
255	16.06	13.5	14.5	15.5	16	16	16	16	16

AUXILIARY ADC (ADUC845 ONLY)

Table 18. ADuC845 Typical Output RMS Noise (μV) vs. Update Rate with Chop Enabled

SF Word	Data Update Rate (Hz)	μV
13	105.03	17.46
23	59.36	3.13
27	50.56	4.56
69	19.79	2.66
255	5.35	1.13

Table 19. ADuC845 Typical Peak-to-Peak Resolution (Bits) vs. Update Rate[1] with Chop Enabled

SF Word	Data Update Rate (Hz)	Bits
13	105.03	15.5
23	59.36	18
27	50.56	17.5
69	19.79	18
255	5.35	19.5

[1] ADC converting in bipolar mode.

Table 20. ADuC845 Typical Output RMS Noise (μV) vs. Update Rate with Chop Disabled

SF Word	Data Update Rate (Hz)	μV
3	1365.33	1386.58
13	315.08	34.94
66	62.06	3.2
69	59.36	3.19
81	50.57	3.14
255	16.06	1.71

Table 21. ADuC845 Peak-to-Peak Resolution (Bits) vs. Update Rate with Chop Disabled

SF Word	Data Update Rate (Hz)	Bits
3	1365.33	9
13	315.08	14.5
66	62.06	18
69	59.36	18
81	50.57	18
255	16.06	19

REFERENCE INPUTS

The ADuC845/ADuC847/ADuC848 each have two separate differential reference inputs, REFIN± and REFIN2±. While both references are available for use with the primary ADC, only REFIN± is available for the auxiliary ADC (ADuC845 only). The common-mode range for these differential references is from AGND to AV_{DD}. The nominal external reference voltage is 2.5 V, with the primary and auxiliary (ADuC845 only) reference select bits configured from the ADC0CON2 and ADC1CON (ADuC845 only), respectively.

When an external reference voltage is used, the primary ADC sees this internally as a 2.56 V reference ($V_{REF} \times 1.024$). Therefore, any calculations of LSB size should account for this. For instance, with a 2.5 V external reference connected and using a gain of 1 on a unipolar range (2.56 V), the LSB size is $(2.56/2^{24}) = 152.6$ nV (if using the 24-bit ADC on the ADuC845 or ADuC847). If a bipolar gain of 4 is used (±640 mV), the LSB size is $(±640 \text{ mV})/2^{24}) = 76.3$ nV (again using the 24-bit ADC on the ADuC845 or ADuC847).

The ADuC845/ADuC847/ADuC848 can also be configured to use the on-chip band gap reference via the XREF0/1 bits in the ADC0CON2 SFR (for primary ADC) or the AXREF bit in ADC1CON (for auxiliary ADC (ADuC845 only)). In this mode of operation, the ADC sees the internal reference of 1.25 V, thereby halving all the input ranges. A consequence of using the internal band gap reference is a noticeable degradation in peak-to-peak resolution. For this reason, operation with an external reference is recommended.

In applications where the excitation (voltage or current) for the transducer on the analog input also drives the reference inputs for the device, the effect of any low frequency noise in the excitation source is removed because the application is ratiometric. If the devices are not used in a ratiometric configuration, use a low noise reference. Recommended reference voltage sources for the ADuC845/ADuC847/ADuC848 include the ADR421, REF43, and REF192.

The reference inputs provide a high impedance, dynamic load to external connections. Because the impedance of each reference input is dynamic, resistor/capacitor combinations on these pins can cause dc gain errors, depending on the output impedance of the source that is driving the reference inputs. Reference voltage sources, such as those mentioned above, for example, the ADR421, typically have low output impedances, and, therefore, decoupling capacitors on the REFIN± or REFIN2± inputs would be recommended (typically 0.1 μF). Deriving the reference voltage from an external resistor configuration means that the reference input sees a significant external source impedance. External decoupling of the REFIN± and/or REFIN2± inputs is not recommended in this type of configuration.

BURNOUT CURRENT SOURCES

The primary ADC on the ADuC845 and the ADC on the ADuC847 and ADuC848 incorporate two 100 nA constant current generators that are used to detect a failure in a connected sensor. One sources current from the AV_{DD} to AIN(+), and one sinks current from AIN(−) to AGND. These currents are only configurable for use on AIN5/AIN6 and/or AIN7/AIN8 in differential mode only, from the ICON.6 bit in the ICON SFR

DATA OUTPUT CODING

When the primary ADC is configured for unipolar operation, the output coding is natural (straight) binary with a zero differential input voltage resulting in a code of 000...000, a midscale voltage resulting in a code of 100...000, and a full-scale voltage resulting in a code of 111...111. The output code for any analog input voltage on the main ADC can be represented as follows:

$$Code - (AIN \times GAIN \times 2^N)/(1.024 \times V_{REF})$$

where:

AIN is the analog input voltage.
GAIN is the PGA gain setting, that is, 1 on the 2.56 V range and 128 on the 20 mV range, and $N = 24$ (16 on the ADuC848).

The output code for any analog input voltage on the auxiliary ADC can be represented as follows:

$$Code = (AIN \times 2^N)/(V_{REF})$$

with the same definitions as used for the primary ADC above.

When the primary ADC is configured for bipolar operation, the coding is offset binary with negative full-scale voltage resulting in a code of 000...000, a zero differential voltage resulting in a code of 800…000, and a positive full-scale voltage resulting in a code of 111...111. The output from the primary ADC for any analog input voltage can be represented as follows:

$$Code = 2^{N-1}[(AIN \times GAIN)/(1.024 \times V_{REF}) + 1]$$

where:

AIN is the analog input voltage.
GAIN is the PGA gain, that is, 1 on the ±2.56 V range and 128 on the ±20 mV range.
$N = 24$ (16 on the ADuC848).

The output from the auxiliary ADC in bipolar mode can be represented as follows:

$$Code = 2^{N-1}\ [(AIN/V_{REF}) + 1]$$

EXCITATION CURRENTS

The ADuC845/ADuC847/ADuC848 contain two matched, software-configurable 200 μA current sources. Both source current from AV_{DD}, which is directed to either or both of the IEXC1 (Pin 11 whose alternate functions are P1.6/AIN7) or IEXC2 (Pin 12, whose alternate functions are P1.7/AIN8) pins on the device. These currents are controlled via the lower four bits in the ICON register (Table 30). These bits not only enable the current sources but also allow the configuration of the currents such that 200 μA can be sourced individually from both pins or can be combined to give a 400 μA source from one or the other of the outputs. These sources can be used to excite external resistive bridge or RTD sensors (see Figure 71).

ADC POWER-ON

The ADC typically takes 0.5 ms to power up from an initial start-up sequence or following a power-down event.

Using the DAC

The on-chip DAC architecture consists of a resistor string DAC followed by an output buffer amplifier, the functional equivalent of which is shown in Figure 33.

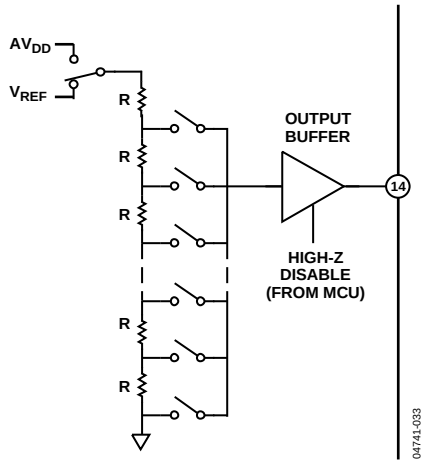

Figure 33. Resistor String DAC Functional Equivalent

Features of this architecture include inherent guaranteed monotonicity and excellent differential linearity. As shown in Figure 33, the reference source for the DAC is user-selectable in software. It can be either AV_{DD} or V_{REF}. In 0 V-to-AV_{DD} mode, the DAC output transfer function spans from 0 V to the voltage at the AV_{DD} pin. In 0 V-to-V_{REF} mode, the DAC output transfer function spans from 0 V to the internal V_{REF} (2.5 V). The DAC output buffer amplifier features a true rail-to-rail output stage implementation. This means that, unloaded, each output is capable of swinging to within less than 100 mV of both AV_{DD} and ground. Moreover, the DAC's linearity specification (when driving a 10 kΩ resistive load to ground) is guaranteed through the full transfer function except Codes 0 to 48 in 0 V-to-V_{REF} mode; Codes 0 to 100; and Codes 3950 to 4095 in 0 V-to-V_{DD} mode.

Linearity degradation near ground and V_{DD} is caused by saturation of the output amplifier; a general representation of its effects (neglecting offset and gain error) is shown in Figure 34. The dotted line indicates the ideal transfer function, and the solid line represents what the transfer function might look like with endpoint nonlinearities due to saturation of the output amplifier.

Note that Figure 34 represents a transfer function in 0-to-V_{DD} mode only. In 0 V-to-V_{REF} mode (with $V_{REF} < V_{DD}$), the lower nonlinearity would be similar, but the upper portion of the transfer function would follow the ideal line to the end, showing no signs of the high-end endpoint linearity error.

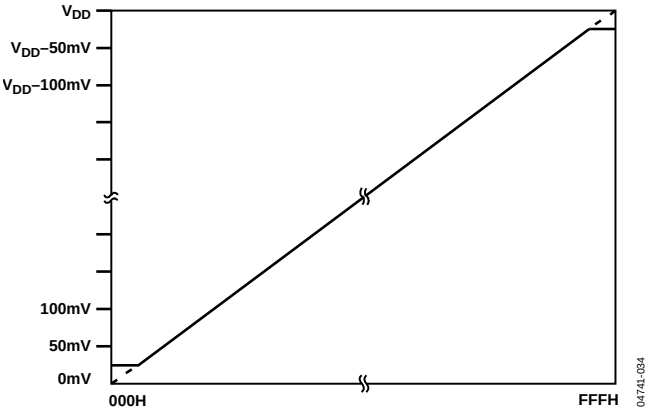

Figure 34. Endpoint Nonlinearities Due to Amplifier Saturation

The endpoint nonlinearities shown in Figure 34 become worse as a function of output loading. Most data sheet specifications assume a 10 kΩ resistive load to ground at the DAC output. As the output is forced to source or sink more current, the nonlinear regions at the top or bottom, respectively, of Figure 34 become larger. With larger current demands, this can significantly limit output voltage swing. Figure 35 and Figure 36 illustrate this behavior. Note that the upper trace in each of these figures is valid only for an output range selection of 0 V to AV_{DD}. In 0 V-to-V_{REF} mode, DAC loading does not cause high-side voltage nonlinearities while the reference voltage remains below the upper trace in the corresponding figure. For example, if AV_{DD} = 3 V and V_{REF} = 2.5 V, the high-side voltage is not affected by loads of less than 5 mA. But around 7 mA, the upper curve in Figure 36 drops below 2.5 V (V_{REF}), indicating that at these higher currents, the output is not capable of reaching V_{REF}.

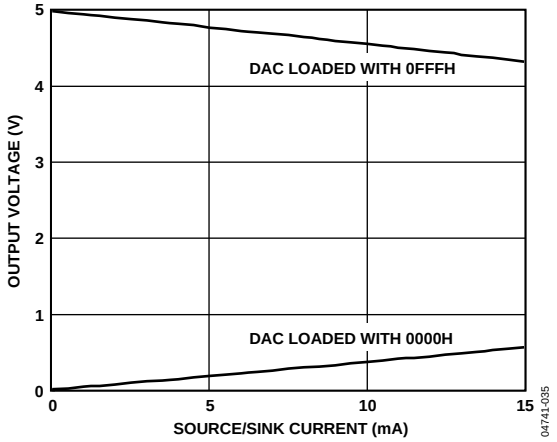

Figure 35. Source and Sink Current Capability with $V_{REF} = AV_{DD} = 5$ V

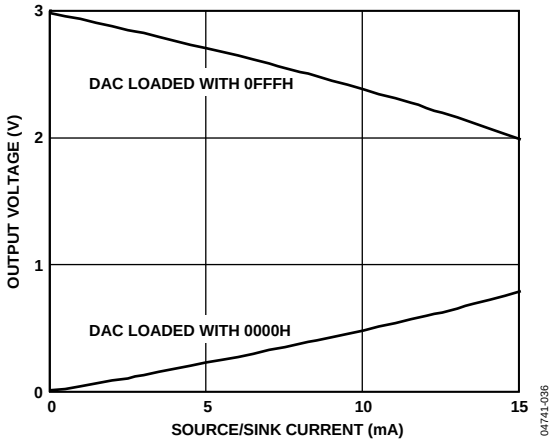

Figure 36. Source and Sink Current Capability with V_{REF} = AV_{DD} = 3 V

For larger loads, the current drive capability may not be sufficient. To increase the source and sink current capability of the DAC, an external buffer should be added as shown in Figure 37.

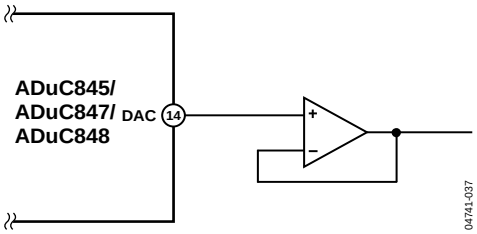

Figure 37. Buffering the DAC Output

The internal DAC output buffer also features a high impedance disable function. In the chip's default power-on state, the DAC is disabled and its output is in a high impedance state (or three-state) where it remains inactive until enabled in software. This means that if a zero output is desired during power-on or power-down transient conditions, a pull-down resistor must be added to each DAC output. Assuming that this resistor is in place, the DAC output remains at ground potential whenever the DAC is disabled.

PULSE-WIDTH MODULATOR (PWM)

The ADuC845/ADuC847/ADuC848 has a highly flexible PWM offering programmable resolution and an input clock. The PWM can be configured in six different modes of operation. Two of these modes allow the PWM to be configured as a Σ-Δ DAC with up to 16 bits of resolution. A block diagram of the PWM is shown in Figure 38.

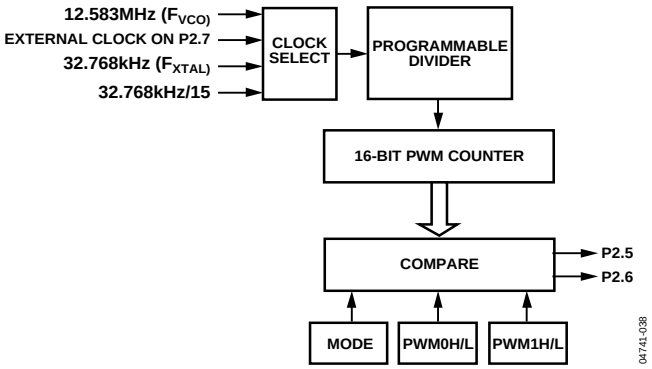

Figure 38. PWM Block Diagram

The PWM uses control SFR, PWMCON, and four data SFRs: PWM0H, PWM0L, PWM1H, and PWM1L.

PWMCON (as described in Table 34) controls the different modes of operation of the PWM as well as the PWM clock frequency. PWM0H/L and PWM1H/L are the data registers that determine the duty cycles of the PWM outputs at P2.5 and P2.6.

To use the PWM user software, first write to PWMCON to select the PWM mode of operation and the PWM input clock. Writing to PWMCON also resets the PWM counter. In any of the 16-bit modes of operation (Modes 1, 3, 4, 6), user software should write to the PWM0L or PWM1L SFRs first. This value is written to a hidden SFR. Writing to the PWM0H or PWM1H SFRs updates both the PWMxH and the PWMxL SFRs but does not change the outputs until the end of the PWM cycle in progress. The values written to these 16-bit registers are then used in the next PWM cycle.

PWMCON PWM Control SFR

SFR Address: AEH
Power-On Default: 00H
Bit Addressable: No

Table 34. PWMCON PWM Control SFR

Bit No.	Name	Description
7	–––	Not Implemented. Write Don't Care.
6, 5, 4	PWM2, PWM1, PWM0	PMW Mode Selection. PWM2 PWM1 PWM0 0 0 0 Mode 0: PWM disabled. 0 0 1 Mode 1: Single 16-bit output with programmable pulse and cycle time. 0 1 0 Mode 2: Twin 8-bit outputs. 0 1 1 Mode 3: Twin 16-bit outputs. 1 0 0 Mode 4: Dual 16-bit pulse density outputs. 1 0 1 Mode 5: Dual 8-bit outputs. 1 1 0 Mode 6: Dual 16-bit pulse density RZ outputs. 1 1 1 Mode 7: PWM counter reset with outputs not used.
3, 2	PWS1, PWS0	PWM Clock Source Divider. PWS1 PWS0 0 0 Selected clock. 0 1 Selected clock divided by 4. 1 0 Selected clock divided by 16. 1 1 Selected clock divided by 64.
1, 0	PWC1, PWC0	PWM Clock Source Selection. PWC1 PWC0 0 0 F_{XTAL}/15 (2.184 kHz). 0 1 F_{XTAL} (32.768 kHz). 1 0 External input on P2.7. 1 1 F_{VCO} (12.58 MHz).

PWM Pulse Width High Byte (PWM0H)

SFR Address: B2H
Power-On Default: 00H
Bit Addressable: No

Table 35. PWM0H: PWM Pulse Width High Byte

PWM0H.7	PWM0H.6	PWM0H.5	PWM0H.4	PWM0H.3	PWM0H.2	PWM0H.1	PWM0H.0
0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

PWM Pulse Width Low Byte (PWM0L)

SFR Address: B1H
Power-On Default: 00H
Bit Addressable: No

Table 36. PWM0L: PWM Pulse Width Low Byte

PWM0L.7	PWM0L.6	PWM0L.5	PWM0L.4	PWM0L.3	PWM0L.2	PWM0L.1	PWM0L.0
0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

PWM Cycle Width High Byte (PWM1H)

SFR Address: B4H
Power-On Default: 00H
Bit Addressable: No

Table 37. PWM1H: PWM Cycle Width High Byte

PWM1H.7	PWM1H.6	PWM1H.5	PWM1H.4	PWM1H.3	PWM1H.2	PWM1H.1	PWM1H.0
0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

PWM Cycle Width Low Byte (PWM1L)

SFR Address: B3H
Power-On Default: 00H
Bit Addressable: No

Table 38. PWM1L: PWM Cycle Width Low Byte

PWM1L.7	PWM1L.6	PWM1L.5	PWM1L.4	PWM1L.3	PWM1L.2	PWM1L.1	PWM1L.0
0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Mode 0

In Mode 0, the PWM is disabled, allowing P2.5 and P2.6 to be used as normal digital I/Os.

Mode 1 (Single-Variable Resolution PWM)

In Mode 1, both the pulse length and the cycle time (period) are programmable in user code, allowing the resolution of the PWM to be variable. PWM1H/L sets the period of the output waveform. Reducing PWM1H/L reduces the resolution of the PWM output but increases the maximum output rate of the PWM. For example, setting PWM1H/L to 65536 gives a 16-bit PWM with a maximum output rate of 192 Hz (12.583 MHz/65536). Setting PWM1H/L to 4096 gives a 12-bit PWM with a maximum output rate of 3072 Hz (12.583 MHz/4096).

PWM0H/L sets the duty cycle of the PWM output waveform as shown in Figure 39.

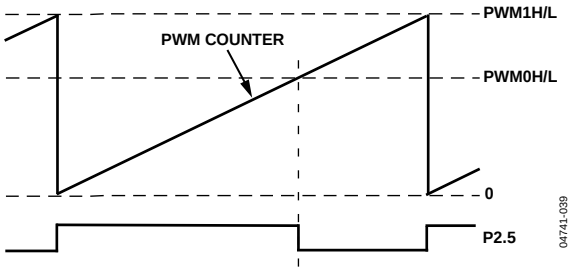

Figure 39. PWM in Mode 1

Mode 2 (Twin 8-Bit PWM)

In Mode 2, the duty cycle and the resolution of the PWM outputs are programmable. The maximum resolution of the PWM output is 8 bits.

PWM1L sets the period for both PWM outputs. Typically, this is set to 255 (FFH) to give an 8-bit PWM, although it is possible to reduce this as necessary. A value of 100 can be loaded here to give a percentage PWM, that is, the PWM is accurate to 1%.

The outputs of the PWM at P2.5 and P2.6 are shown in Figure 40. As can be seen, the output of PWM0 (P2.5) goes low when the PWM counter equals PWM0L. The output of PWM1 (P2.6) goes high when the PWM counter equals PWM1H and goes low again when the PWM counter equals PWM0H. Setting PWM1H to 0 ensures that both PWM outputs start simultaneously.

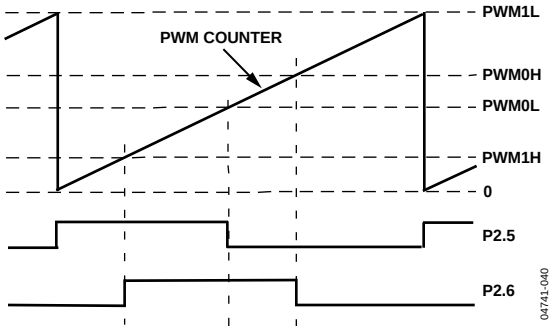

Figure 40. PWM Mode 2

Mode 3 (Twin 16-Bit PWM)

In Mode 3, the PWM counter is fixed to count from 0 to 65536, giving a fixed 16-bit PWM. Operating from the 12.58 MHz core clock results in a PWM output rate of 192 Hz. The duty cycle of the PWM outputs at P2.5 and P2.6 are independently programmable.

As shown in Figure 41, while the PWM counter is less than PWM0H/L, the output of PWM0 (P2.5) is high. Once the PWM counter equals PWM0H/L, PWM0 (P2.5) goes low and remains low until the PWM counter rolls over.

Similarly, while the PWM counter is less than PWM1H/L, the output of PWM1 (P2.6) is high. Once the PWM counter equals PWM1H/L, PWM1 (P2.6) goes low and remains low until the PWM counter rolls over.

In this mode, both PWM outputs are synchronized, that is, once the PWM counter rolls over to 0, both PWM0 (P2.5) and PWM1 (P2.6) go high.

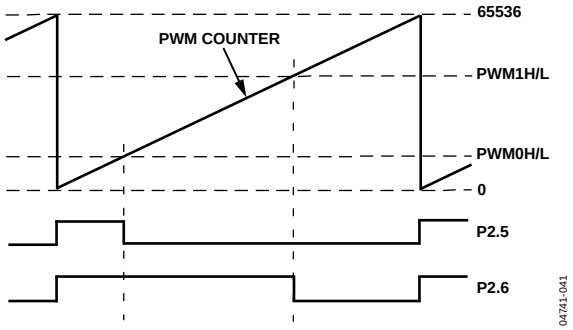

Figure 41. PWM Mode 3

Mode 4 (Dual NRZ 16-Bit Σ-Δ DAC)

Mode 4 provides a high speed PWM output similar to that of a Σ-Δ DAC. Typically, this mode is used with the PWM clock equal to 12.58 MHz.

In this mode, P2.5 and P2.6 are updated every PWM clock (80 ns in the case of 12.58 MHz). Over any 65536 cycles (16-bit PWM), PWM0 (P2.5) is high for PWM0H/L cycles and low for (65536 – PWM0H/L) cycles. Similarly, PWM1 (P2.6) is high for PWM1H/L cycles and low for (65536 – PWM1H/L) cycles.

If PWM1H is set to 4010H (slightly above one-quarter of FS), typically P2.6 is low for three clocks and high for one clock (each clock is approximately 80 ns). Over every 65536 clocks, the PWM compromises for the fact that the output should be slightly above one-quarter of full scale, by having a high cycle followed by only two low cycles.

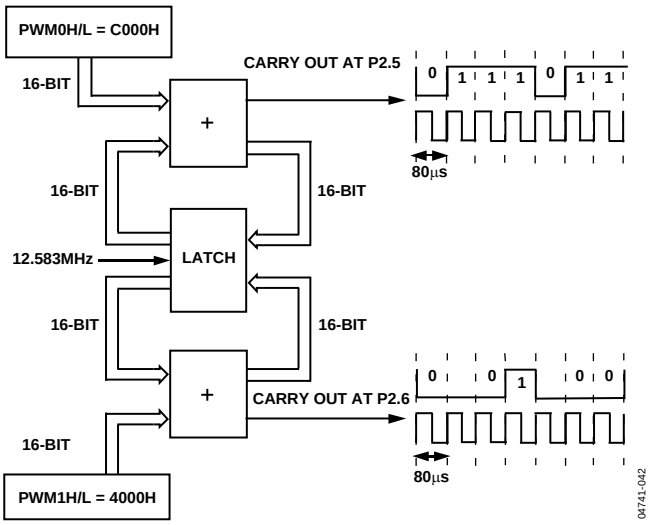

Figure 42. PWM Mode 4

For faster DAC outputs (at lower resolution), write 0s to the LSBs that are not required with a 1 in the LSB position. If, for example, only 12-bit performance is required, write 0001 to the 4 LSBs. This means that a 12-bit accurate Σ-Δ DAC output can occur at 3 kHz. Similarly, writing 00000001 to the 8 LSBs gives an 8-bit accurate Σ-Δ DAC output at 49 kHz.

ON-CHIP PLL (PLLCON)

The ADuC845/ADuC847/ADuC848 are intended for use with a 32.768 kHz watch crystal. A PLL locks onto a multiple (384) of this to provide a stable 12.582912 MHz clock for the system. The core can operate at this frequency or at binary submultiples of it to allow power saving when maximum core performance is not required. The default core clock is the PLL clock divided by 8 or 1.572864 MHz. The ADC clocks are also derived from the PLL clock, with the modulator rate being the same as the crystal oscillator frequency. The control register for the PLL is called PLLCON and is described as follows.

The 5 V parts can be set to a maximum core frequency of 12.58 MHz (CD2...0 = 000) while at 3 V, the maximum core clock rate is 6.29 MHz (CD2...0 = 001). The CD bits should not be set to 000b on the 3 V parts.

The 3 V parts are limited to a core clock speed of 6.29 MHz (CD = 1).

PLLCON PLL Control Register

SFR Address: D7H
Power-On Default: 53H
Bit Addressable: No

Table 39. PLLCON PLL Control Register

Bit No.	Name	Description
7	OSC_PD	Oscillator Power-Down Bit. If low, the 32 kHz crystal oscillator continues running in power-down mode. If high, the 32.768 kHz oscillator is powered down. When this bit is low, the seconds counter continues to count in power-down mode and can interrupt the CPU to exit power-down. The oscillator is always enabled in normal mode.
6	LOCK	PLL Lock Bit. This is a read-only bit. Set automatically at power-on to indicate that the PLL loop is correctly tracking the crystal clock. After power-down, this bit can be polled to wait for the PLL to lock. Cleared automatically at power-on to indicate that the PLL is not correctly tracking the crystal clock. This might be due to the absence of a crystal clock or an external crystal at power-on. In this mode, the PLL output can be 12.58 MHz ± 20%. After the device wakes up from power-down, user code can poll this bit to wait for the PLL to lock. If LOCK = 0, the PLL is not locked.
5	–––	Not Implemented. Write Don't Care.
4	LTEA	EA Status. Read-only bit. Reading this bit returns the state of the external $\overline{EA}$ pin latched at reset or power-on.
3	FINT	Fast Interrupt Response Bit. Set by the user to enable the response to any interrupt to be executed at the fastest core clock frequency. Cleared by the user to disable the fast interrupt response feature. This function must not be used on 3 V parts.
2, 1, 0	CD2, CD1, CD0	CPU (Core Clock) Divider Bits. This number determines the frequency at which the core operates. CD2 CD1 CD0 Core Clock Frequency (MHz) 0 0 0 12.582912. Not a valid selection on 3 V parts. 0 0 1 6.291456 (Maximum core clock rate allowed on the 3 V parts) 0 1 0 3.145728 0 1 1 1.572864 (Default core frequency) 1 0 0 0.786432 1 0 1 0.393216 1 1 0 0.196608 1 1 1 0.098304 On 3 V parts (ADuC84xBCPxx-3 or ADuC84xBSxx-3), the CD settings can be only CD = 1; CD = 0 is not a valid selection. If CD = 0 is selected on a 3 V part by writing to PLLCON, the instruction is ignored, and the previous CD value is retained. The Fast Interrupt bit (FINT) must not be used on 3 V parts since it automatically sets the CD bits to 0, which is not a valid setting.

I2CADD—I²C Address Register 1

Function:	Holds one of the I²C peripheral addresses for the device. It may be overwritten by user code. The uC001 Application Note describes the format of the I²C standard 7-bit address.
SFR Address:	9BH
Power-On Default:	55H
Bit Addressable:	No

I2CADD1—I²C Address Register 2

Function:	Same as the I2CADD.
SFR Address:	F2H
Power-On Default:	7FH
Bit Addressable:	No

I2CDAT—I²C Data Register

Function:	The I2CDAT SFR is written to by user code to transmit data, or read by user code to read data just received by the I²C interface. Accessing I2CDAT automatically clears any pending I²C interrupt and the I2CI bit in the I2CCON SFR. User code should access I2CDAT only once per interrupt cycle.
SFR Address:	9AH
Power-On Default:	00H
Bit Addressable:	No

The main features of the MicroConverter I²C interface are

- Only two bus lines are required: a serial data line (SDATA) and a serial clock line (SCLOCK).
- An I²C master can communicate with multiple slave devices. Because each slave device has a unique 7-bit address, single master/slave relationships can exist at all times even in a multislave environment.
- The ability to respond to two separate addresses when operating in slave mode.
- On-chip filtering rejects <50 ns spikes on the SDATA and the SCLOCK lines to preserve data integrity.

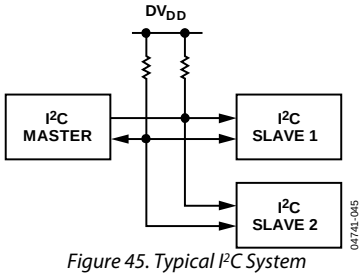

Figure 45. Typical I²C System

Software Master Mode

The ADuC845/ADuC847/ADuC848 can be used as an I²C master device by configuring the I²C peripheral in master mode and writing software to output the data bit-by-bit. This is referred to as a software master. Master mode is enabled by setting the I2CM bit in the I2CCON register.

To transmit data on the SDATA line, MDE must be set to enable the output driver on the SDATA pin. If MDE is set, the SDATA pin is pulled high or low depending on whether the MDO bit is set or cleared. MCO controls the SCLOCK pin and is always configured as an output in master mode. In master mode, the SCLOCK pin is pulled high or low depending on the whether MCO is set or cleared.

To receive data, MDE must be cleared to disable the output driver on SDATA. Software must provide the clocks by toggling the MCO bit and reading the SDATA pin via the MDI bit. If MDE is cleared, MDI can be used to read the SDATA pin. The value of the SDATA pin is latched into MDI on a rising edge of SCLOCK. MDI is set if the SDATA pin is high on the last rising edge of SCLOCK. MDI is cleared if the SDATA pin is low on the last rising edge of SCLOCK.

Software must control MDO, MCO, and MDE appropriately to generate the start condition, slave address, acknowledge bits, data bytes, and stop conditions. These functions are described in the uC001 Application Note.

SPICON—SPI Control Register

SFR Address: F8H
Power-On Default: 05H
Bit Addressable: Yes

Table 41. SPICON SFR Bit Designations

Bit No.	Name	Description
7	ISPI	SPI Interrupt Bit. Set by the MicroConverter at the end of each SPI transfer. Cleared directly by user code or indirectly by reading the SPIDAT SFR.
6	WCOL	Write Collision Error Bit. Set by the MicroConverter if SPIDAT is written to while an SPI transfer is in progress. Cleared by user code.
5	SPE	SPI Interface Enable Bit. Set by user code to enable SPI functionality. Cleared by user code to enable standard Port 2 functionality.
4	SPIM	SPI Master/Slave Mode Select Bit. Set by user code to enable master mode operation (SCLOCK is an output). Cleared by user code to enable slave mode operation (SCLOCK is an input).
3	CPOL[1]	Clock Polarity Bit. Set by user code to enable SCLOCK idle high. Cleared by user code to enable SCLOCK idle low.
2	CPHA[1]	Clock Phase Select Bit. Set by user code if the leading SCLOCK edge is to transmit data. Cleared by user code if the trailing SCLOCK edge is to transmit data.
1, 0	SPR1, SPR0	SPI Bit-Rate Bits. SPR1 SPR0 Selected Bit Rate 0 0 $f_{core}/2$ 0 1 $f_{core}/4$ 1 0 $f_{core}/8$ 1 1 $f_{core}/16$

[1] The CPOL and CPHA bits should both contain the same values for master and slave devices.

Note that both SPI and I²C use the same ISR (Vector Address 3BH); therefore, when using SPI and I²C simultaneously, it is necessary to check the interfaces following an interrupt to determine which one caused the interrupt.

SPIDAT: SPI Data Register

SFR Address: 7FH
Power-On Default: 00H
Bit Addressable: No

TIMECON—TIC Control Register

SFR Address: A1H
Power-On Default: 00H
Bit Addressable: No

Table 45. TIMECON SFR Bit Designations

Bit No.	Name	Description
7	----	Not Implemented. Write Don't Care.
6	TFH	Twenty-Four Hour Select Bit. Set by the user to enable the hour counter to count from 0 to 23. Cleared by the user to enable the hour counter to count from 0 to 255.
5, 4	ITS1, ITS0	Interval Timebase Selection Bits. ITS1 ITS0 Interval Timebase 0 0 1/128 Second 0 1 Seconds 1 0 Minutes 1 1 Hours
3	ST1	Single Time Interval Bit. Set by the user to generate a single interval timeout. If set, a timeout clears the TIEN bit. Cleared by the user to allow the interval counter to be automatically reloaded and start counting again at each interval timeout.
2	TII	TIC Interrupt Bit. Set when the 8-bit interval counter matches the value in the INTVAL SFR. Cleared by user software.
1	TIEN	Time Interval Enable Bit. Set by the user to enable the 8-bit time interval counter. Cleared by the user to disable the interval counter.
0	TCEN	Time Clock Enable Bit. Set by the user to enable the time clock to the time interval counters. Cleared by the user to disable the clock to the time interval counters and reset the time interval SFRs to the last value written to them by the user. The time registers (HTHSEC, SEC, MIN, and HOUR) can be written while TCEN is low.

UART SERIAL INTERFACE

The serial port is full duplex, meaning that it can transmit and receive simultaneously. It is also receive buffered, meaning that it can begin receiving a second byte before a previously received byte is read from the receive register. However, if the first byte is still not read by the time reception of the second byte is complete, the first byte is lost. The physical interface to the serial data network is via Pins RxD(P3.0) and TxD(P3.1), while the SFR interface to the UART comprises SBUF and SCON, as described in this section.

SBUF SFR

Both the serial port receive and transmit registers are accessed through the SBUF SFR (SFR address = 99H). Writing to SBUF loads the transmit register, and reading SBUF accesses a physically separate receive register.

SCON UART—Serial Port Control Register

SFR Address: 98H
Power-On Default: 00H
Bit Addressable: Yes

Table 54. SCON SFR Bit Designations

Bit No.	Name	Description
7, 6	SM0, SM1	UART Serial Mode Select Bits. These bits select the serial port operating mode as follows:
		SM0 SM1 Selected Operating Mode.
		0 0 Mode 0: Shift register, fixed baud rate (Core_Clk/2).
		0 1 Mode 1: 8-bit UART, variable baud rate.
		1 0 Mode 2: 9-bit UART, fixed baud rate (Core_Clk/32) or (Core_Clk/16).
		1 1 Mode 3: 9-bit UART, variable baud rate.
5	SM2	Multiprocessor Communication Enable Bit.
		Enables multiprocessor communication in Modes 2 and 3.
		In Mode 0, SM2 should be cleared.
		In Mode 1, if SM2 is set, RI is not activated if a valid stop bit was not received. If SM2 is cleared, RI is set as soon as the byte of data is received.
		In Modes 2 or 3, if SM2 is set, RI is not activated if the received ninth data bit in RB8 is 0.
		If SM2 is cleared, RI is set as soon as the byte of data is received.
4	REN	Serial Port Receive Enable Bit.
		Set by user software to enable serial port reception.
3	TB8	Serial Port Transmit (Bit 9).
		The data loaded into TB8 is the ninth data bit transmitted in Modes 2 and 3. Cleared by user software to disable serial port reception.
2	RB8	Serial Port Receiver Bit 9.
		The ninth data bit received in Modes 2 and 3 is latched into RB8. For Mode 1, the stop bit is latched into RB8.
1	TI	Serial Port Transmit Interrupt Flag.
		Set by hardware at the end of the eighth bit in Mode 0, or at the beginning of the stop bit in Modes 1, 2, and 3. TI must be cleared by user software.
0	RI	Serial Port Receive Interrupt Flag.
		Set by hardware at the end of the eighth bit in Mode 0, or halfway through the stop bit in Modes 1, 2, and 3. RI must be cleared by software.

SBUF—UART Serial Port Data Register

SFR Address: 99H
Power-On Default: 00H
Bit Addressable: No

Timer 3 Generated Baud Rates

The high integer dividers in a UART block mean that high speed baud rates are not always possible. Also, generating baud rates requires the exclusive use of a timer, rendering it unusable for other applications when the UART is required. To address this problem, the ADuC845/ADuC847/ADuC848 have a dedicated baud rate timer (Timer 3) specifically for generating highly accurate baud rates. Timer 3 can be used instead of Timer 1 or Timer 2 for generating very accurate high speed UART baud rates including 115200 and 230400. Timer 3 also allows a much wider range of baud rates to be obtained. In fact, every desired bit rate from 12 bps to 393216 bps can be generated to within an error of ±0.8%. Timer 3 also frees up the other three timers, allowing them to be used for different applications. A block diagram of Timer 3 is shown in Figure 61.

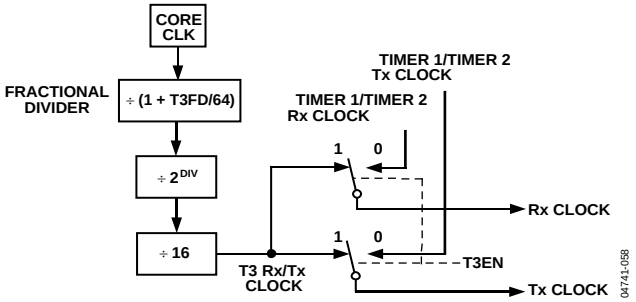

Figure 61. Timer 3, UART Baud Rate

Two SFRs (T3CON and T3FD) are used to control Timer 3. T3CON is the baud rate control SFR, allowing Timer 3 to be used to set up the UART baud rate, and to set up the binary divider (DIV).

The appropriate value to write to the DIV2-1-0 bits can be calculated using the following formula where f_{CORE} is defined in PLLCON SFR. Note that the DIV value must be rounded down.

$$DIV = \frac{\log\left(\frac{Core\ Clock\ Frequency}{16 \times Baud\ Rate}\right)}{\log(2)}$$

T3FD is the fractional divider ratio required to achieve the required baud rate. The appropriate value for T3FD can be calculated with the following formula:

$$T3FD = \frac{2 \times Core\ Clock\ Frequency}{2^{DIV-1} \times Baud\ Rate} - 64$$

Note that T3FD should be rounded to the nearest integer. Once the values for DIV and T3FD are calculated, the actual baud rate can be calculated with the following formula:

$$Actual\ Baud\ Rate = \frac{2 \times Core\ Clock\ Frequency}{2^{DIV-1} \times (T3FD + 64)}$$

For example, to get a baud rate of 9600 while operating at a core clock frequency of 1.5725 MHz, that is, CD = 3,

$$DIV = \log(1572500/(16 \times 9600))/\log 2 = 3.35 = 3$$

Note that the DIV result is rounded down.

$$T3FD = (2 \times 1572500)/(2^{3-1} \times 9600) - 64 = 18 = 12H$$

Therefore, the actual baud rate is 9588 bps, which gives an error of 0.12%.

The T3CON and T3FD registers are used to control Timer 3.

T3CON – Timer 3 Control Register

SFR Address: 9EH
Power-On Default: 00H
Bit Addressable: No

TIMING SPECIFICATIONS

AC inputs during testing are driven at DV_{DD} – 0.5 V for Logic 1 and 0.45 V for Logic 0. Timing measurements are made at V_{IH} min for Logic 1 and V_{IL} max for Logic 0 as shown in Figure 72.

For timing purposes, a port pin is no longer floating when a 100 mV change from load voltage occurs. A port pin begins to float when a 100 mV change from the loaded V_{OH}/V_{OL} level occurs as shown in Figure 72.

C_{LOAD} for all outputs = 80 pF, unless otherwise noted.

AV_{DD} = 2.7 V to 3.6 V or 4.75 V to 5.25 V, DV_{DD} = 2.7 V to 3.6 V or 4.75 V to 5.25 V; all specifications T_{MIN} to T_{MAX}, unless otherwise noted.

Table 64. CLOCK INPUT (External Clock Driven XTAL1) Parameter

		32.768 kHz External Crystal			
		Min	Typ	Max	Unit
t_{CK}	XTAL1 Period		30.52		µs
t_{CKL}	XTAL1 Width Low		6.26		µs
t_{CKH}	XTAL1 Width High		6.26		µs
t_{CKR}	XTAL1 Rise Time		9		ns
t_{CKF}	XTAL1 Fall Time		9		ns
$1/t_{CORE}$	Core Clock Frequency[1]	0.098	1.57	12.58	MHz
t_{CORE}	Core Clock Period[2]		0.636		µs
t_{CYC}	Machine Cycle Time[3]	10.2	0.636	0.08	µs

[1] ADuC845/ADuC847/ADuC848 internal PLL locks onto a multiple (512 times) of the 32.768 kHz external crystal frequency to provide a stable 12.58 MHz internal clock for the system. The core can operate at this frequency or at a binary submultiple called Core_Clk, selected via the PLLCON SFR.
[2] This number is measured at the default Core_Clk operating frequency of 1.57 MHz.
[3] ADuC845/ADuC847/ADuC848 machine cycle time is nominally defined as 1/Core_Clk.

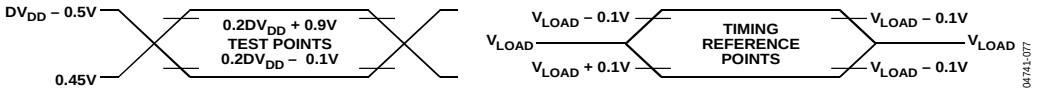

Figure 72. Timing Waveform Characteristics

NOTES

I²C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

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